25-06063

Low Power, Low Noise Voltage References with Sink/Source Capability

ADR360/ADR361/ADR363/ADR364/ADR365/ADR366

FEATURES

Compact TSOT packages Low temperature coefficient B grade: 9 ppm/°C A grade: 25 ppm/°C Initial accuracy B grade: ±3 mV maximum A grade: ±6 mV maximum Ultralow output noise: 6.8 μV p-p (0.1 Hz to 10 Hz) Low dropout: 300 mV Low supply current: 190 μA maximum No external capacitor required Output current: +5 mA/−1 mA Wide temperature range: −40°C to +125°C Qualified for automotive applications

APPLICATIONS

Battery-powered instruments Portable medical instruments Data acquisition systems Industrial process controls Automotive

PIN CONFIGURATION

Table 1. ADR36x Family of Devices

¹ Contact Analog Devices for other voltage options.

supply of 300 mV above the output. Their advanced design eliminates the need for external capacitors, which further reduces board space and system cost. The combination of low power operation, small size, and ease of use makes the ADR36x precision voltage references ideally suited for battery-operated applications.

See the [Ordering Guide](#page-19-1) for automotive grades.

GENERAL DESCRIPTION

The ADR360/ADR361/ADR363/ADR364/ADR365/ADR366 are precision 2.048 V, 2.5 V, 3.0 V, 4.096 V, 5.0 V, and 3.3 V band gap voltage references that offer low power and high precision in tiny footprints. Using patented temperature drift curvature correction techniques from Analog Devices, Inc., the ADR36x references achieve a low temperature drift of 9 ppm/°C in a TSOT package.

The ADR36x family of micropower, low dropout voltage references provides a stable output voltage from a minimum

Rev. D

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REVISION HISTORY

10/10—Rev. C to Rev. D

7/07—Rev. B to Rev. C

2/07—Rev. A to Rev. B

3/06—Rev. 0 to Rev. A

4/05—Revision 0: Initial Version

SPECIFICATIONS

ADR360 ELECTRICAL CHARACTERISTICS

 V_{IN} = 2.35 V to 15 V, T_A = 25°C, unless otherwise noted.

Table 2.

ADR361 ELECTRICAL CHARACTERISTICS

 $V_{\rm IN}$ = 2.8 V to 15 V, T_A = 25°C, unless otherwise noted.

Table 3.

ADR363 ELECTRICAL CHARACTERISTICS

 V_{IN} = 3.3 V to 15 V, T_A = 25°C, unless otherwise noted.

Table 4.

ADR364 ELECTRICAL CHARACTERISTICS

 $V_{\rm IN}$ = 4.4 V to 15 V, T_A = 25°C, unless otherwise noted.

Table 5.

ADR365 ELECTRICAL CHARACTERISTICS

 $V_{\rm IN}$ = 5.3 V to 15 V, T_A = 25°C, unless otherwise noted.

Table 6.

ADR366 ELECTRICAL CHARACTERISTICS

 $V_{\rm IN}$ = 3.6 V to 15 V, T_A = 25°C, unless otherwise noted.

Table 7.

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

Table 8.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 9. Thermal Resistance

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 2. ADR360 Output Voltage vs. Temperature

Figure 4. ADR363 Output Voltage vs. Temperature

Figure 5. ADR365 Output Voltage vs. Temperature

Figure 7. ADR365 Supply Current vs. Input Voltage

Figure 10. ADR360 Line Regulation vs. Temperature, $V_{IN} = 2.45$ V to 15 V

Figure 11. ADR361 Line Regulation vs. Temperature, $V_{IN} = 2.8$ V to 15 V

Figure 12. ADR365 Line Regulation vs. Temperature, $V_{IN} = 5.3$ V to 15 V

Figure 13. ADR361 Dropout Voltage vs. Load Current

Figure 17. ADR363 0.1 Hz to 10 Hz Noise

Figure 19. ADR365 0.1 Hz to 10 Hz Noise

50 45 40 OUTPUT IMPEDANCE (Q) **OUTPUT IMPEDANCE (Ω) 35 30 25 20 15 10 5 100ko**
100 **100ko 100ko 100ko 100ko 100ko 100ko 100ko 100ko 100ko** 100ko 100ko 100ko 100ko 100ko 100ko 100ko 100ko 100k
100ko 100ko $\frac{1}{100}$ **1k 10k FREQUENCY (Hz)**

Figure 21. Output Impedance vs. Frequency

Figure 22. Ripple Rejection Ratio vs. Frequency

Figure 23. ADR361 Line Transient Response (Increasing), No Capacitors

Figure 29. ADR361 Turn-Off Response Time at 5 V

Figure 30. ADR361 Turn-On Response Time, 0.1 μF Output Capacitor

Figure 31. ADR361 Turn-Off Response Time, 0.1 μF Output Capacitor

TERMINOLOGY

Temperature Coefficient

The change of output voltage with respect to operating temperature changes normalized by the output voltage at 25°C. This parameter is expressed in ppm/°C and can be determined by

$$
TCV_{OUT}[\text{ppm/}{}^{\circ}\text{C}] = \frac{V_{OUT}(T_2) - V_{OUT}(T_1)}{V_{OUT}(25^{\circ}\text{C}) \times (T_2 - T_1)} \times 10^6
$$

where:

 V_{OUT} (25 $^{\circ}$ C) = V_{OUT} at 25 $^{\circ}$ C. $V_{OUT}(T_1) = V_{OUT}$ at Temperature 1. V_{OUT} (T_2) = V_{OUT} at Temperature 2.

Line Regulation

The change in output voltage due to a specified change in input voltage. This parameter accounts for the effects of self-heating. Line regulation is expressed in either percent per volt, parts per million per volt, or microvolts per volt change in input voltage.

Load Regulation

The change in output voltage due to a specified change in load current. This parameter accounts for the effects of self-heating. Load regulation is expressed in either microvolts per milliampere, parts per million per milliampere, or ohms of dc output resistance.

Long-Term Stability

The typical shift of output voltage at 25°C on a sample of parts subjected to a test of 1000 hours at 25°C.

$$
\Delta V_{OUT} = V_{OUT}(t_o) - V_{OUT}(t_1)
$$

$$
\Delta V_{OUT} [ppm] = \left(\frac{V_{OUT}(t_o) - V_{OUT}(t_1)}{V_{OUT}(t_o)} \times 10^6\right)
$$

where:

 $V_{OUT}(t_0) = V_{OUT}$ at 25 $°C$ at Time 0. $V_{OUT}(t_1) = V_{OUT}$ at 25°C after 1000 hours operation at 25°C.

Thermal Hysteresis

The change of output voltage after the device is cycled from +25°C to −40°C to +125°C and back to +25°C. This is a typical value from a sample of parts put through such a cycle.

$$
V_{OUT_HYS} = V_{OUT} (25^{\circ}\text{C}) - V_{OUT_TC}
$$

$$
V_{OUT_HYS} [\text{ppm}] = \frac{V_{OUT} (25^{\circ}\text{C}) - V_{OUT_TC}}{V_{OUT} (25^{\circ}\text{C})} \times 10^6
$$

where:

 V_{OUT} (25 $^{\circ}$ C) = V_{OUT} at 25 $^{\circ}$ C. V_{OUT_TC} = V_{OUT} at 25 $°C$ after temperature cycle at +25 $°C$ to −40°C to +125°C and back to +25°C.

THEORY OF OPERATION

Band gap references are the high performance solution for low supply voltage and low power voltage reference applications, and the ADR36x family is no exception. The uniqueness of these products lies in their architecture. The ideal zero TC band gap voltage is referenced to the output, not to ground (see [Figure 32](#page-15-1)). Therefore, if noise exists on the ground line, it is greatly attenuated on V_{OUT} . The band gap cell consists of the PNP pair Q53 and Q52 running at unequal current densities. The difference in V_{BE} results in a voltage with a positive TC, which is amplified by a ratio of

$$
2 \times \frac{R59}{R54}
$$

This PTAT voltage, combined with the V_{BE} of Q53 and Q52, produces the stable band gap voltage.

Reduction in the band gap curvature is performed by the ratio of Resistor R44 and Resistor R59, one of which is linearly temperature dependent. Precision laser trimming and other patented circuit techniques are used to further enhance the drift performance.

DEVICE POWER DISSIPATION CONSIDERATIONS

The ADR36x family is capable of delivering load currents to 5 mA with an input voltage ranging from 2.348 V (ADR360 only) to 18 V. When this device is used in applications with large input voltages, care should be taken to avoid exceeding the specified maximum power dissipation or junction temperature because it may result in premature device failure. Use the following formula to calculate a device's maximum junction temperature or dissipation:

$$
P_D = \frac{T_I - T_A}{\theta_{JA}}
$$

where:

 T_I and T_A are the junction and ambient temperatures, respectively. P_D is the device power dissipation.

 θ_{JA} is the device package thermal resistance.

INPUT CAPACITOR

Input capacitors are not required on the ADR36x. There is no limit for the value of the capacitor used on the input, but a 1 μF to 10 μF capacitor on the input improves transient response in applications where the supply suddenly changes. An additional 0.1 μF capacitor in parallel also helps reduce noise from the supply.

OUTPUT CAPACITOR

The ADR36x does not require output capacitors for stability under any load condition. An output capacitor, typically 0.1 μF, filters out low level noise voltage and does not affect the operation of the part. On the other hand, the load transient response can improve with an additional 1 μF to 10 μF output capacitor placed in parallel with the 0.1 μF capacitor. The additional capacitor acts as a source of stored energy for a sudden increase in load current, and the only parameter that degrades is the turn-on time. The amount of degradation depends on the size of the capacitor chosen.

APPLICATIONS INFORMATION **BASIC VOLTAGE REFERENCE CONNECTION**

The circuit in [Figure 33](#page-16-1) illustrates the basic configuration for the ADR36x family. Decoupling capacitors are not required for circuit stability. The ADR36x family is capable of driving capacitive loads from 0 μF to 10 μF. However, a 0.1 μF ceramic output capacitor is recommended to absorb and deliver the charge, as is required by a dynamic load.

Figure 33. Basic Configuration for the ADR36x Family

Stacking Reference ICs for Arbitrary Outputs

Some applications require two reference voltage sources, which are a combined sum of standard outputs. [Figure 34](#page-16-2) shows how this stacked output reference can be implemented.

Figure 34. Stacking Voltage References with the ADR36x

Two reference ICs are used and fed from an unregulated input, V_{IN}. The outputs of the individual ICs are connected in series, which provides two output voltages, V_{OUT1} and V_{OUT2} . V_{OUT1} is the terminal voltage of U1, and V_{OUT2} is the sum of this voltage and the terminal voltage of U2. U1 and U2 are chosen for the two voltages that supply the required outputs (see [Table 10](#page-16-3)). For example, if both U1 and U2 are ADR361s, VouT1 is 2.5 V and V_{OUT2} is 5.0 V.

Table 10. Output

Negative Precision Reference Without Precision Resistors

A negative reference is easily generated by adding an op amp, A1 (see [Figure 35](#page-16-4)). V_{OUTF} and V_{OUTS} are at virtual ground and therefore the negative reference can be taken directly from the output of the op amp. The op amp must be dual-supply, low offset, and rail-to-rail if the negative supply voltage is close to the reference output.

Figure 35. Negative Reference

General-Purpose Current Source

Often in low power applications, the need arises for a precision current source that can operate on low supply voltages. The ADR36x can be configured as a precision current source (see [Figure 36](#page-17-0)). The circuit configuration illustrated is a floating current source with a grounded load. The output voltage of the reference is bootstrapped across R_{SET}, which sets the output current of the load. With this configuration, circuit precision is maintained for load currents ranging from the reference's supply current, typically 150 μA, up to approximately 5 mA.

Trim Terminal

The ADR36x trim terminal can be used to adjust the output voltage over a nominal voltage. This feature allows a system designer to trim system errors by setting the reference to a voltage other than the standard voltage option. Resistor R1 is used for fine adjustments and can be omitted if desired. The resistor values should be carefully chosen to ensure that the maximum current drive of the part is not exceeded.

OUTLINE DIMENSIONS

***COMPLIANT TO JEDEC STANDARDS MO-193-AB WITH THE EXCEPTION OF PACKAGE HEIGHT AND THICKNESS.**

Figure 38. 5-Lead Thin Small Outline Transistor Package [TSOT] (UJ-5) Dimensions shown in millimeters

ORDERING GUIDE

1 Z = RoHS Compliant Part.

 2 W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The ADR365W and ADR366W models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

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